

# LHCb upgrade and physics prospect

## LHCb 升级和物理展望



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第八届全国重味物理与量子色动力学研讨会 / HFQCD 2026

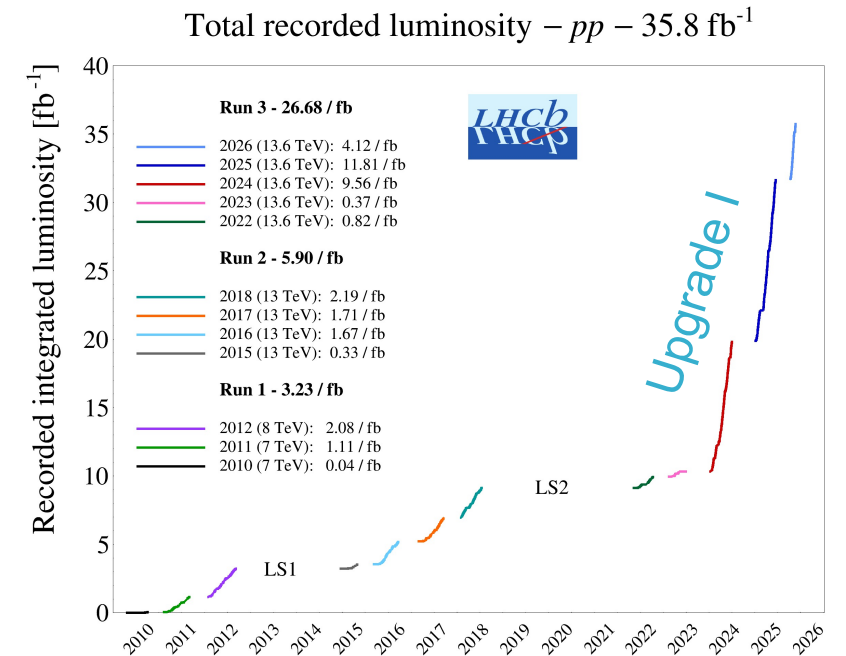
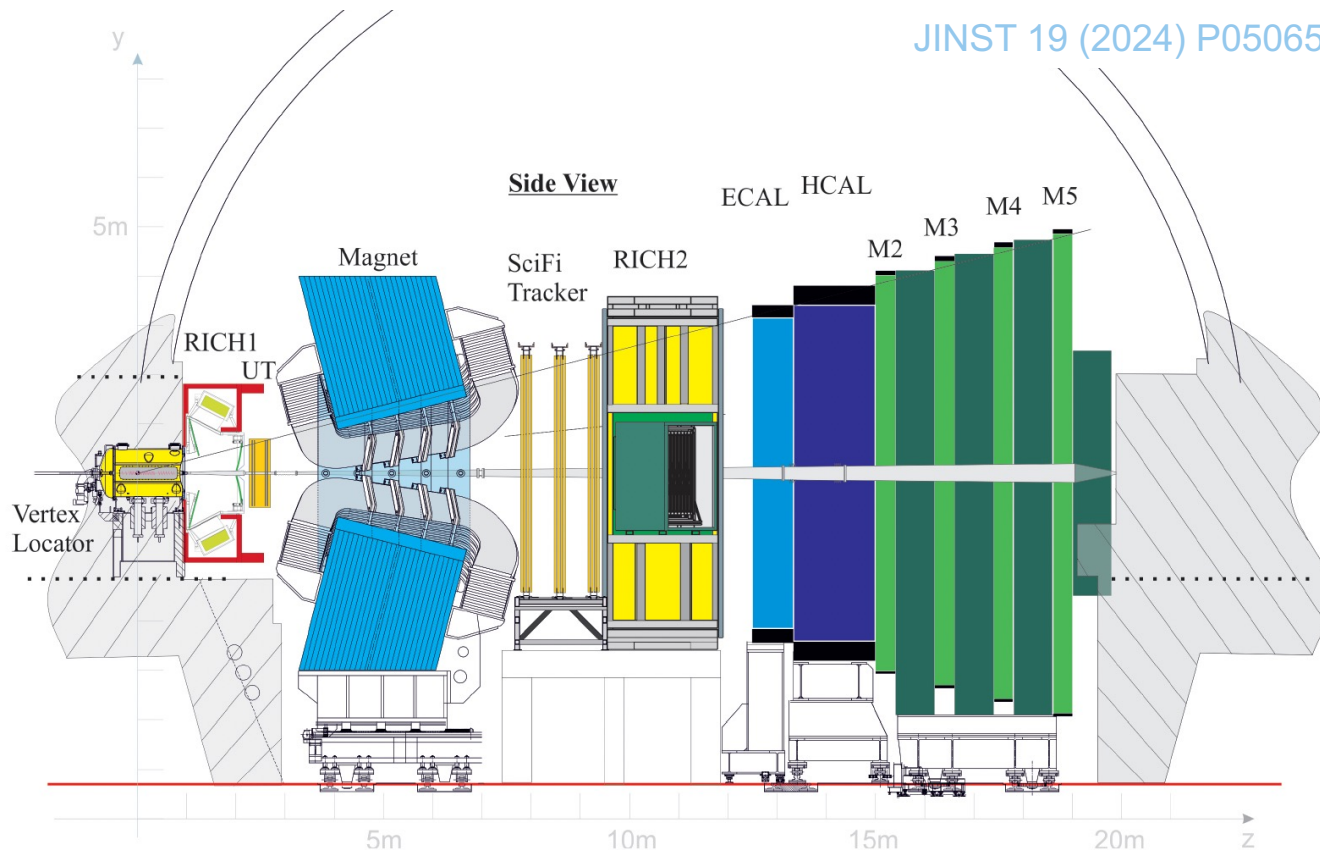
2026年4月26日 @ 重庆

# Content

- LHCb status and Upgrade II
  - With a focus on Chinese contribution:  
**Upstream Tracker**  
**ECAL**
- Physics prospects
  - An example: potential for  $T_{bc}$  search

# LHCb detector ... upgraded!

- Single-arm spectrometer at LHC dedicated for heavy flavour physics

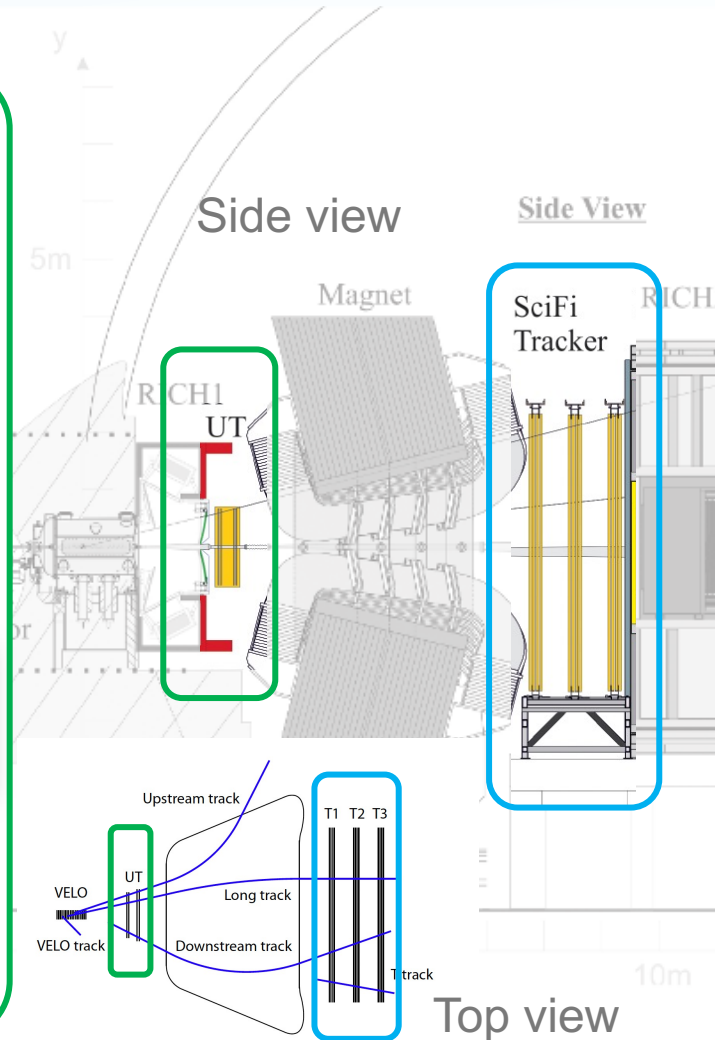


$4.0 \times 10^{32} \text{ cm}^{-2} \text{ s}^{-1} (\times 5)$   
 $\rightarrow 2.0 \times 10^{33} \text{ cm}^{-2} \text{ s}^{-1}$   
 Already  $> 25 \text{ fb}^{-1}$  in Run3

# LHCb-China contribution in tracking system

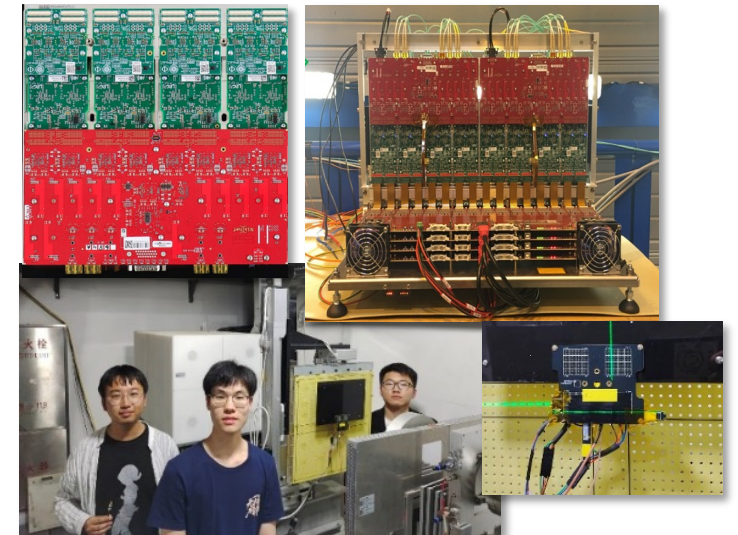
## Upstream Tracker / UT

- UT installation & operation
- Irradiation study of SALT chip with Chinese facilities
- Control & safety software



## Scintillator Fiber Tracker / SciFi

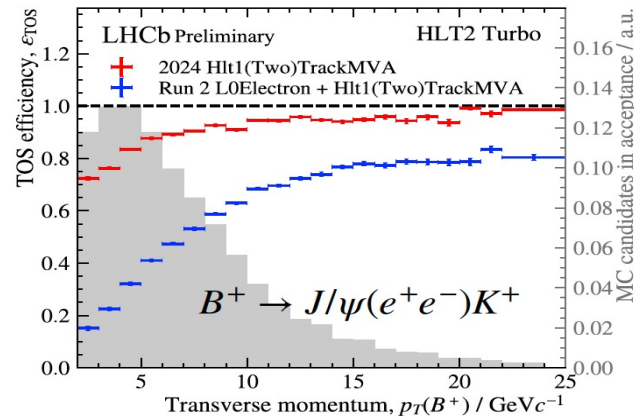
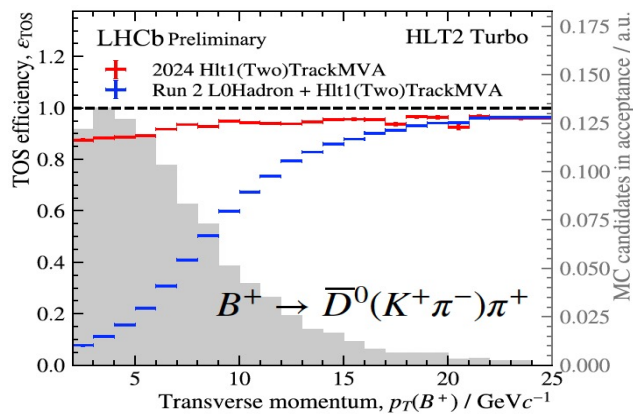
- FE board design and production (>2500 PCB)
- Quality assurance system
- Study of radiation damage on SiPM



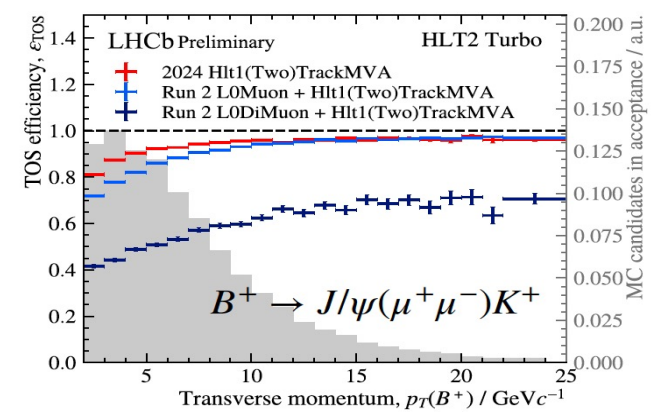
# Run3 Performance

- Trigger efficiency significantly improved – removal of L0 working
  - For hadron and electron as intended, and also for muons

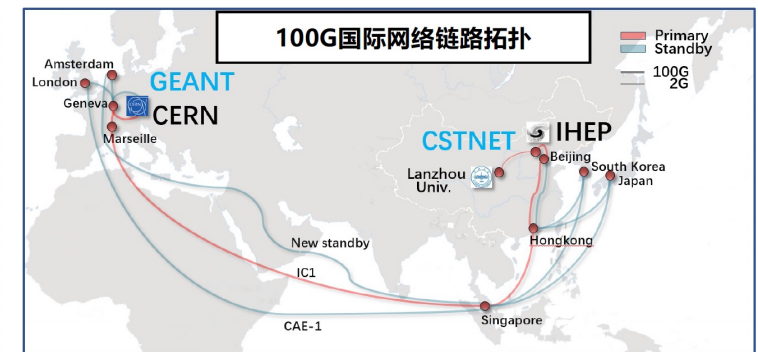
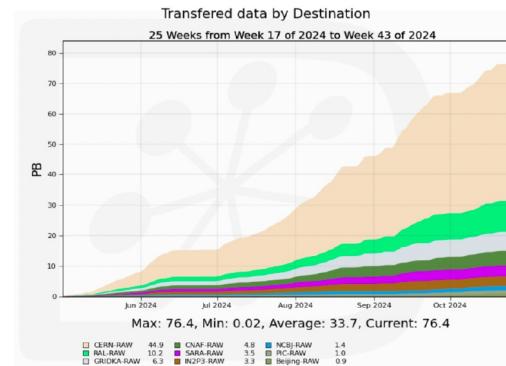
Run 3  
↑  
Run 2



LHCb-Figure-2024-030

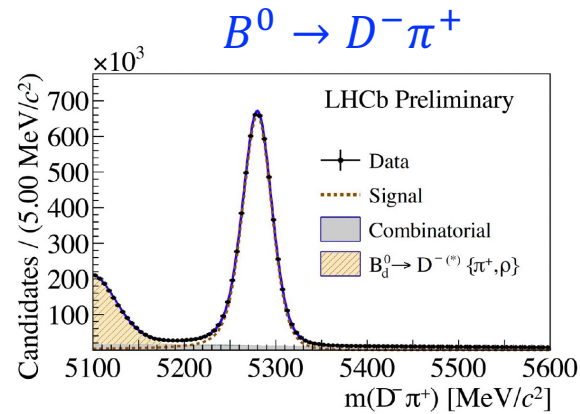
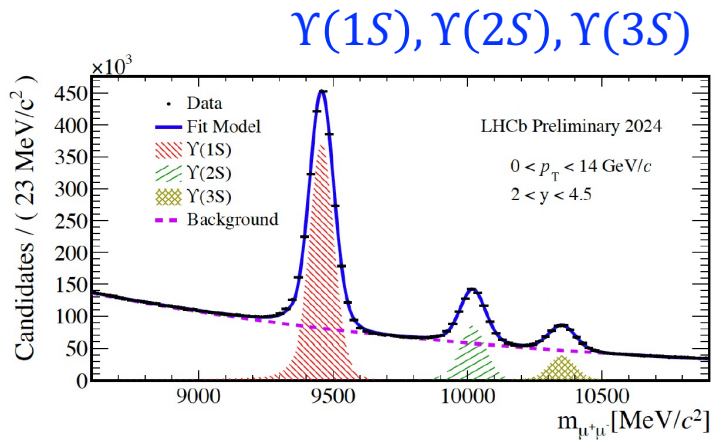


- Efficient use of CPU on WLCG grid to process huge amount of data
  - > 75 PB transferred from online farm
  - Contribution from Beijing Tier-1, Lanzhou Tier-2 operating since 2024

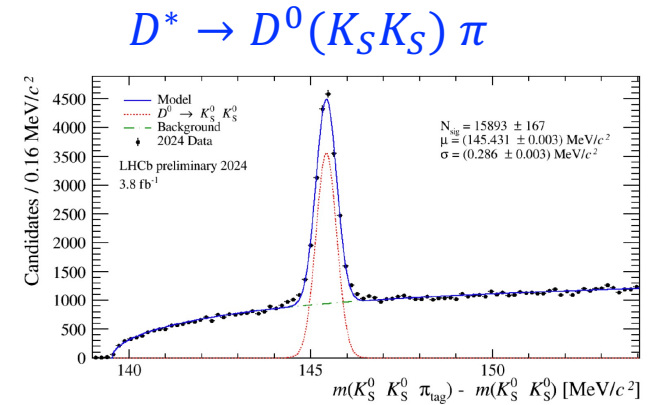


# Performance

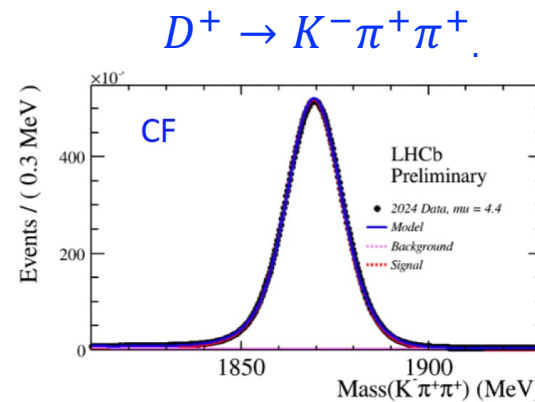
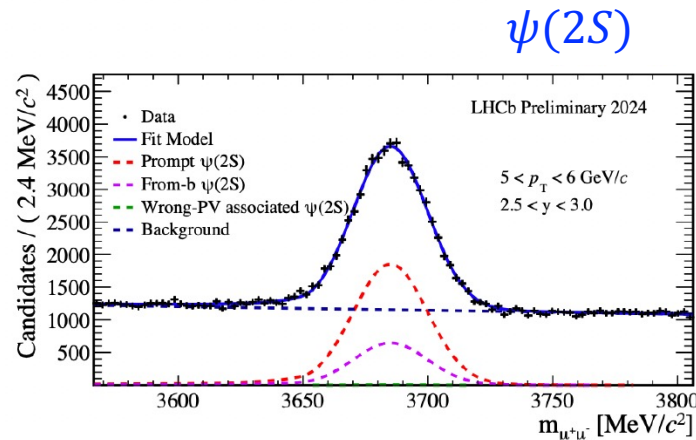
- First glimpse at the mass peaks ...



1.1e6 per fb<sup>-1</sup>, 3× Run2

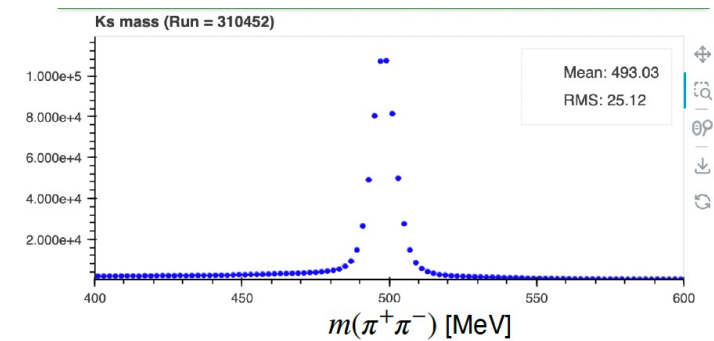


3.6× Run2



1.8e6 per pb<sup>-1</sup>, 2.8× Run2

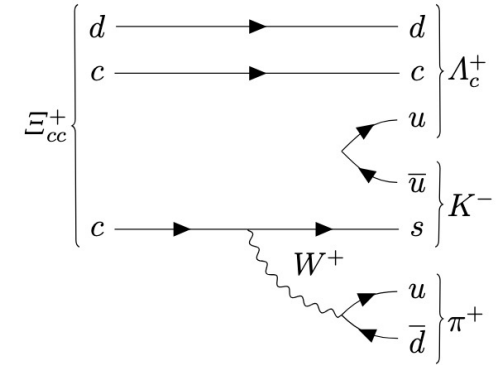
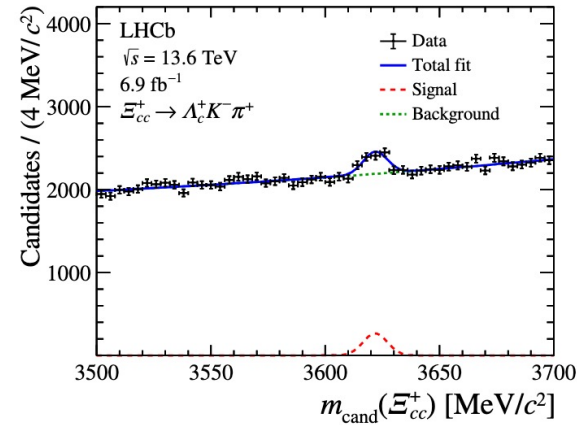
$K_S \rightarrow \pi^+ \pi^-$  at PbPb run



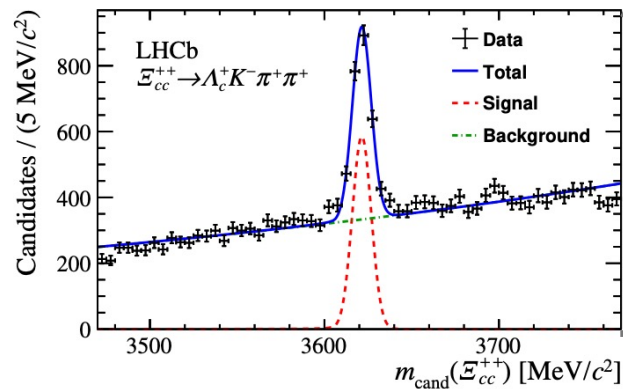
# From performance to results

- First new particle discovered at upgrade LHCb:  $\Xi_{cc}^+$
- But let's take a closer look at the doubly charged  $\Xi_{cc}^{++}$  yield

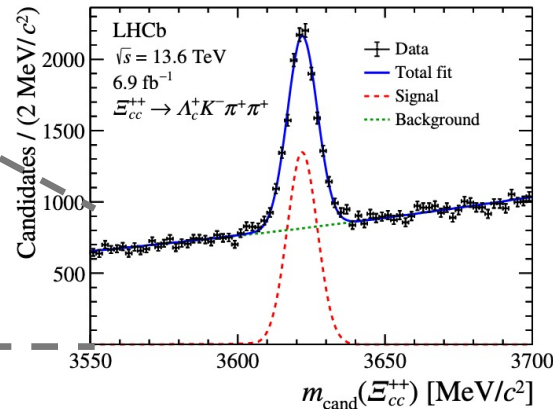
arXiv: 2603.28456



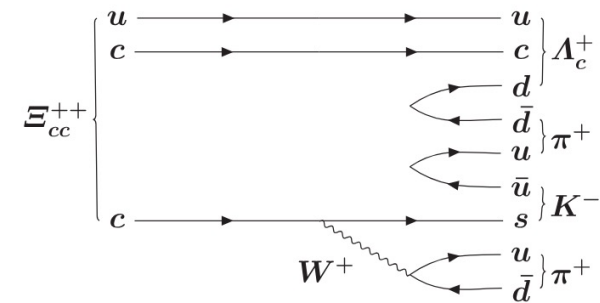
JHEP 02 (2020) 049



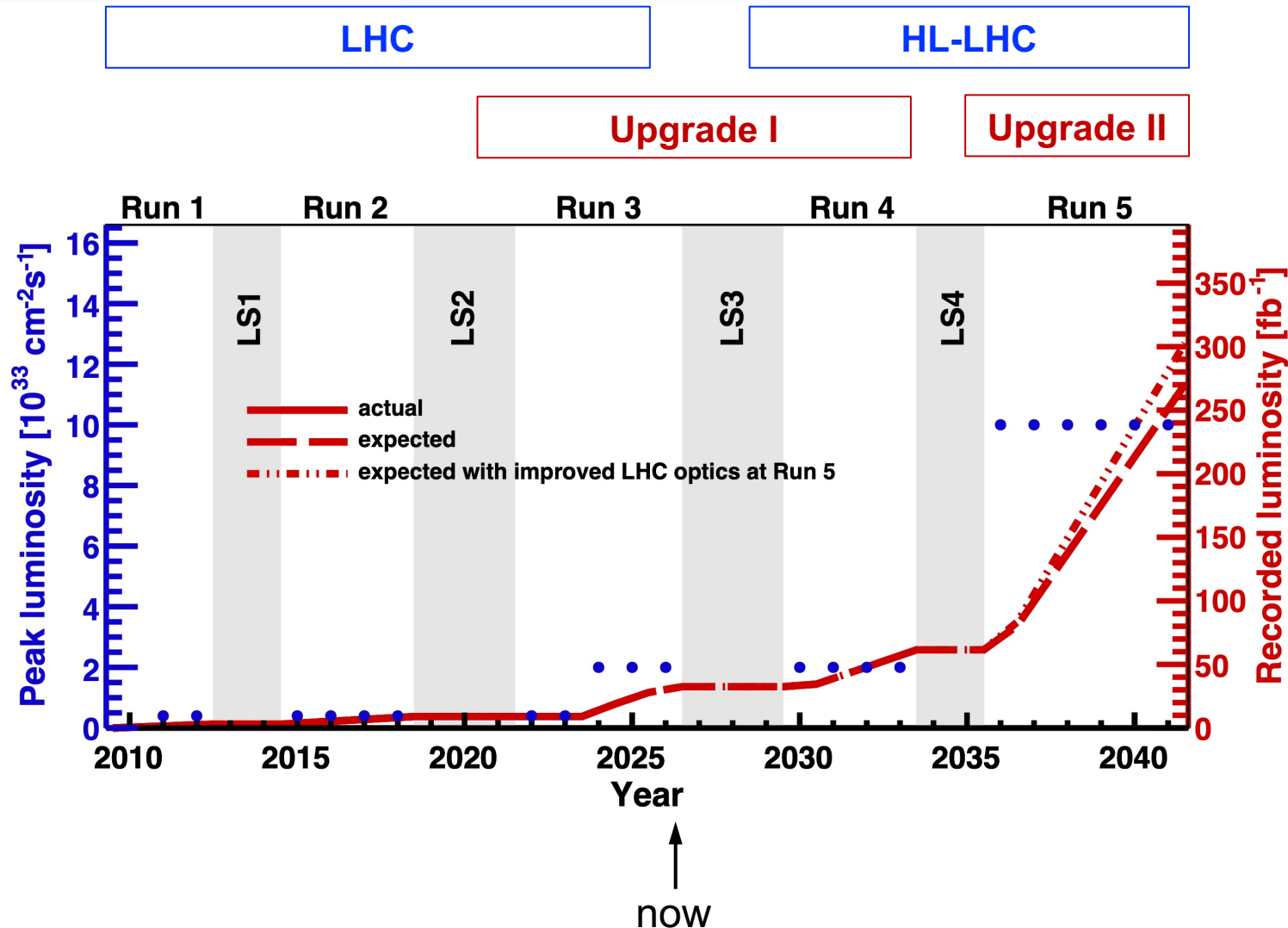
5.6 fb<sup>-1</sup> @ 13 TeV, 2016-2018  
 $\Xi_{cc}^{++}$  Yield: 285 / fb<sup>-1</sup>. in Run 2



6.9 fb<sup>-1</sup> @ 13.6 TeV, 2024  
 $\Xi_{cc}^{++}$  Yield: 1,262 / fb<sup>-1</sup>. in Run3



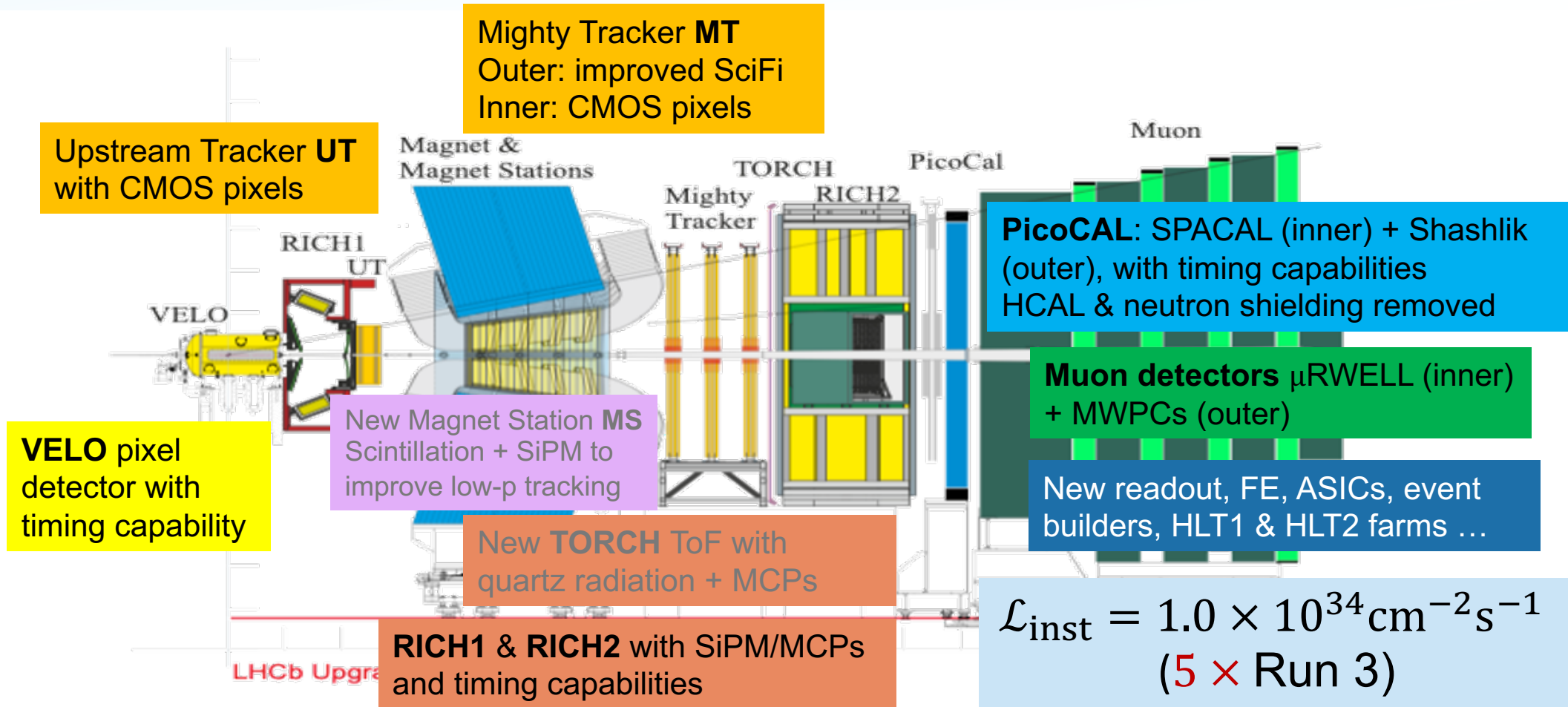
# Upgrade II



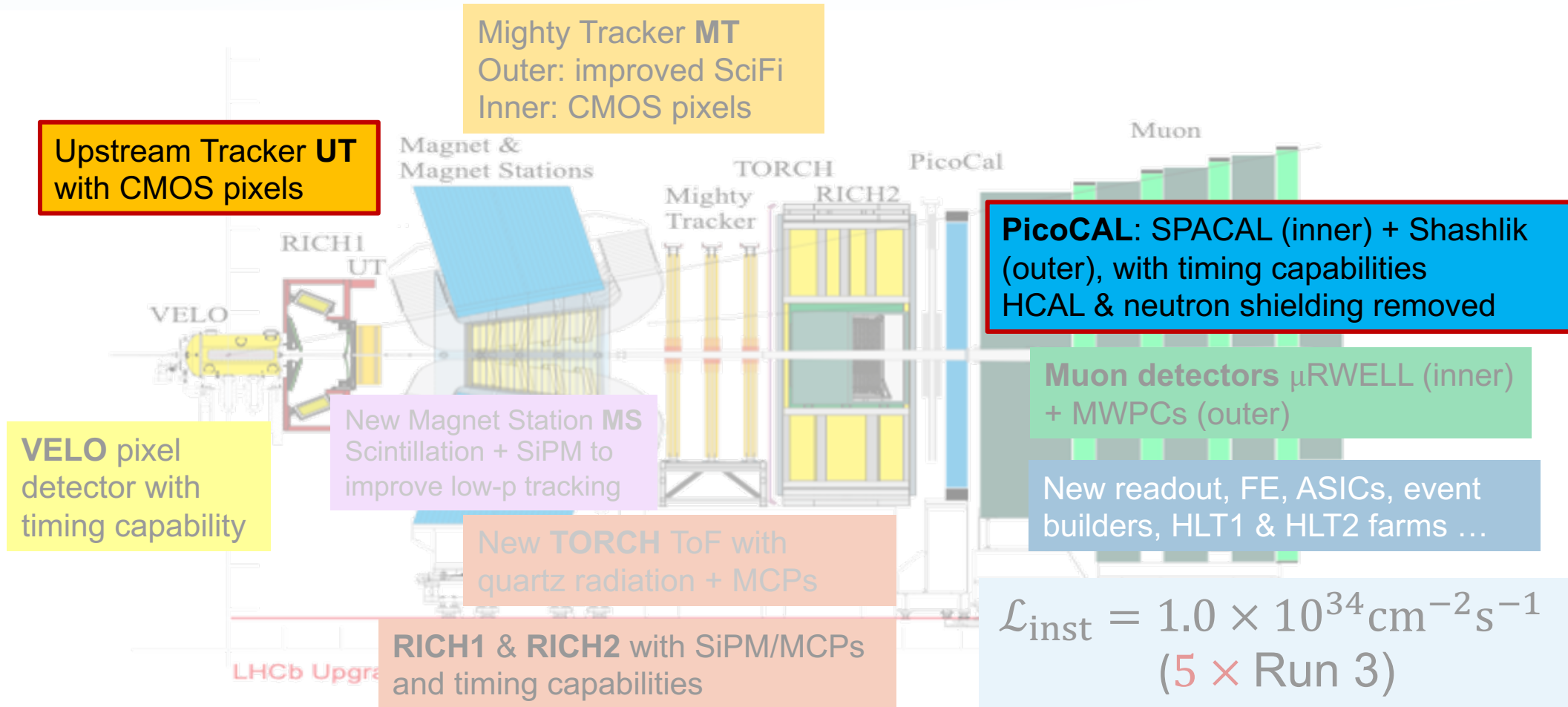
- Upgrade II to fully exploit flavour physics potential in HL-LHC
- Target luminosity:
  - $1.0 \times 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$
  - $300 \text{ fb}^{-1}$
- High-lumi operation challenges:
  - Pile-up:  $\mu \sim 1 \rightarrow 5$  (UI)  $\rightarrow 40$  (UII),
  - High multiplicity ( $\rightarrow$  occupancy)
  - Severe radiation damage
  - High data rates (200 Tb/s)

Expression of interest [CERN-LHCC-2017-003](#)  
 Physics case [CERN-LHCC-2018-027](#)  
 Framework TDR [CERN-LHCC-2021-012](#)  
 Scoping Document [CERN-LHCC-2024-010](#)

# ... an ultimate flavour experiment at HL-LHC

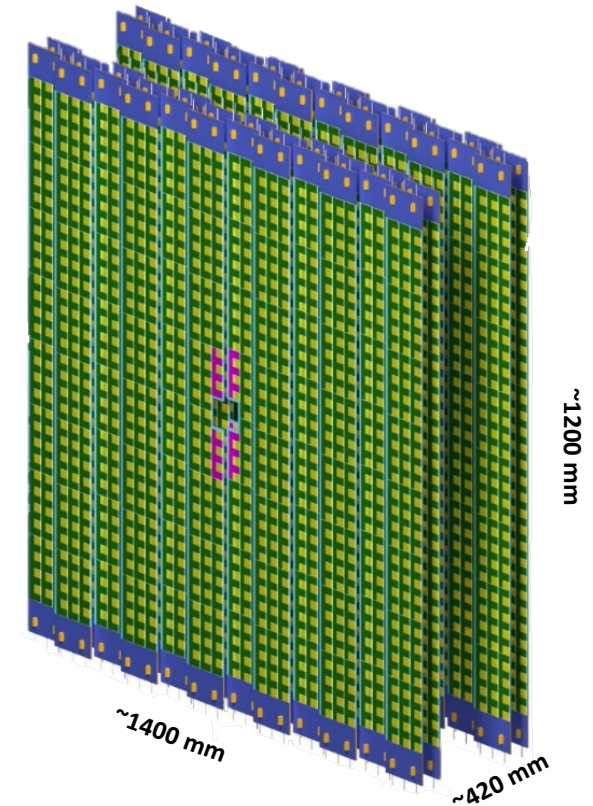
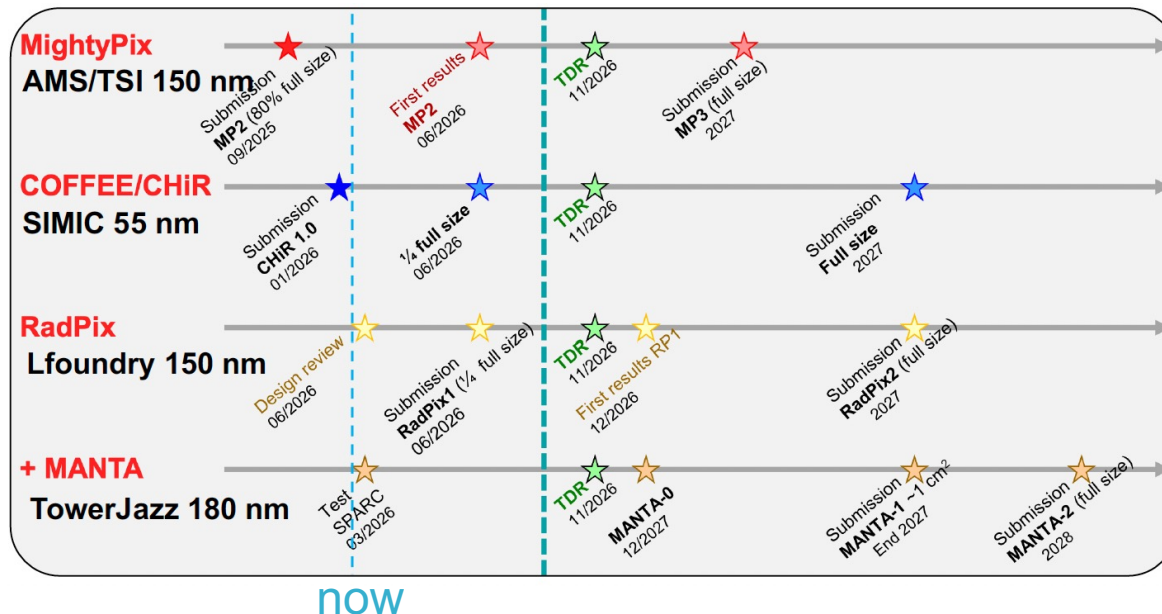


# Chinese LHCb team playing essential roles



# Upstream Pixel Tracker (UP)

- Challenges for UT due to higher luminosity
  - Max hit rate  $\sim 160 \text{ MHz/cm}^2$   $\rightarrow$  higher granularity
  - Ability to tag 25ns bunches  $\rightarrow$  good timing resolution
  - Increased radiation level:
    - NIEL up to  $3 \times 10^{15} n_{\text{eq}}/\text{cm}^2$ , TID up to 240 MRad
- A monolithic CMOS based pixel detector proposed
  - Sensor options: HVCMOS / small electrode CMOS



6.8 m<sup>2</sup> active area in 'middle-scenario'

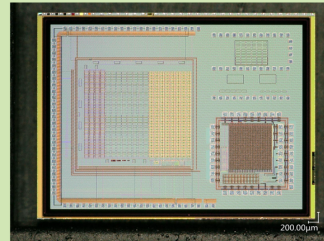
# UP: COFFEE sensors

- Advanced 55nm CMOS R&D driven by Chinese groups using domestic foundry

## COFFEE 2

First HVCMOS 55nm prototype chip

- Breakdown at -70V
- Responsive to laser, X-/beta-ray sources



## CHiR (COFFEE-HiRes)

- Validation of process modification
- Key design feature



CMOS SENSOR IN FIFTY-FIVE NM PROCESS

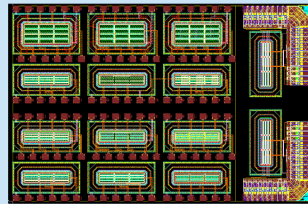
NIM A1069 (2024) 169905  
JINST 20 (2025) C10011

Quarter-size chip submission



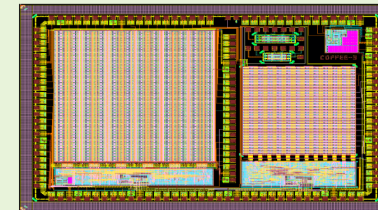
## COFFEE1

- Prototype in LL process
- Validation of deep N-well structure



## COFFEE3

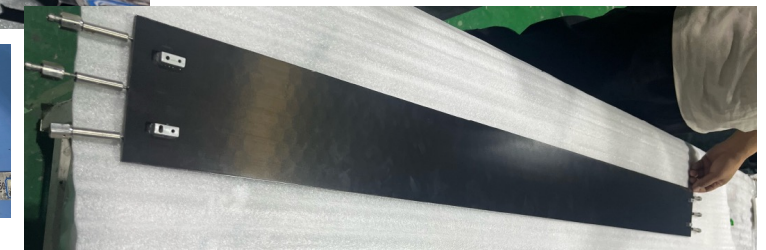
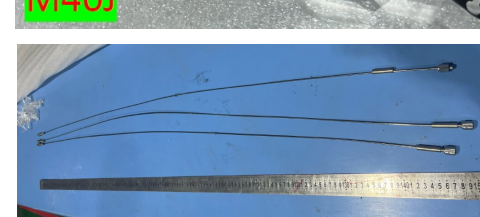
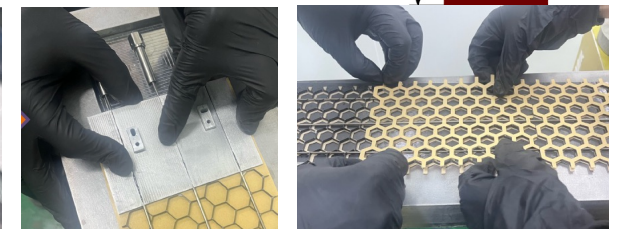
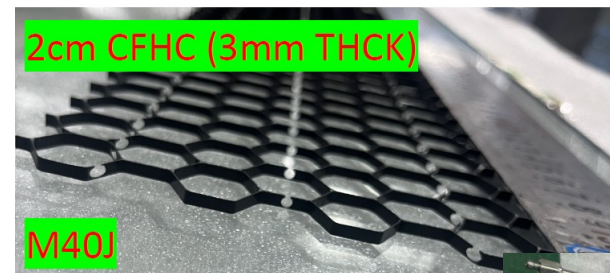
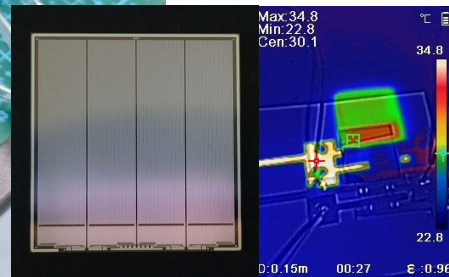
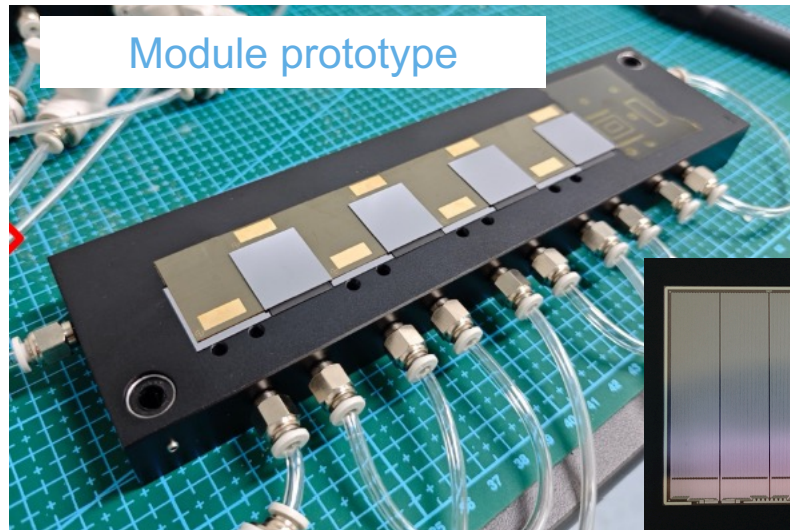
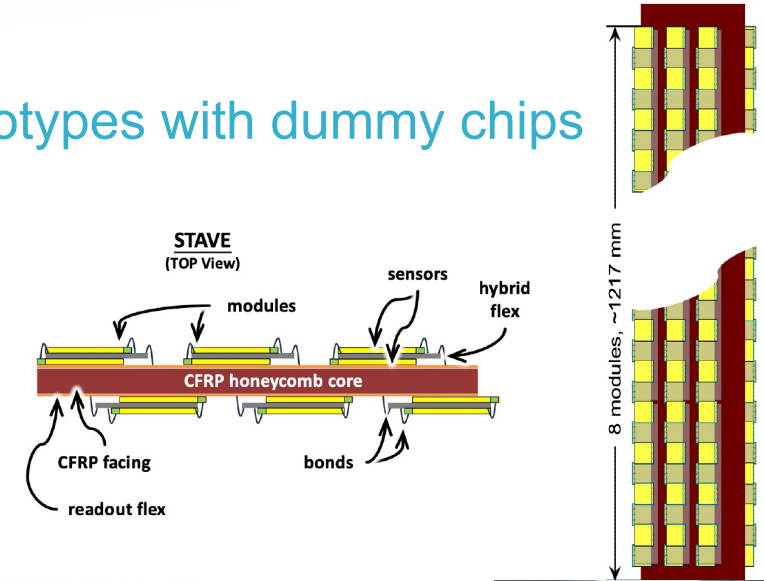
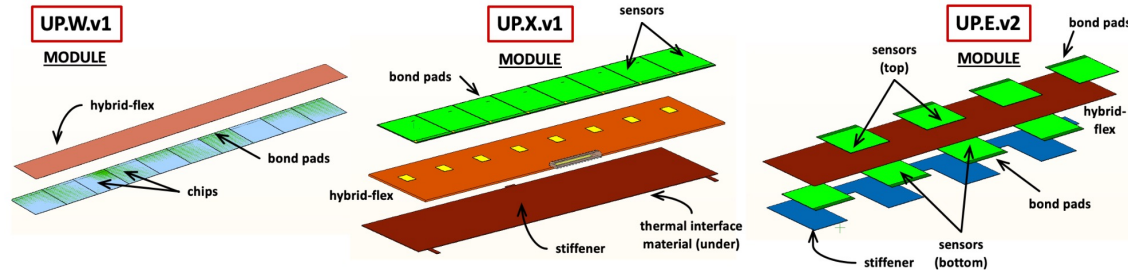
- Two pixel arrays with data-driven readout
- Designed for good timing resolution and moderate power consumption



Large prototype planned ~end 2027

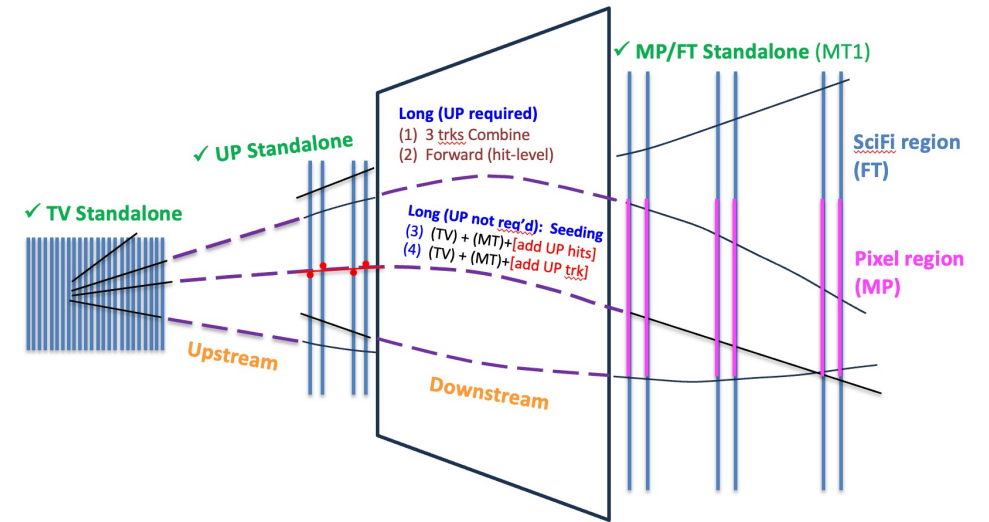
# UP: design concept & prototyping

- Three module concept designs
  - Unique **gapless design** proposed by Chinese groups; prototypes with dummy chips
  - Mechanical prototypes of light-weight bare stave

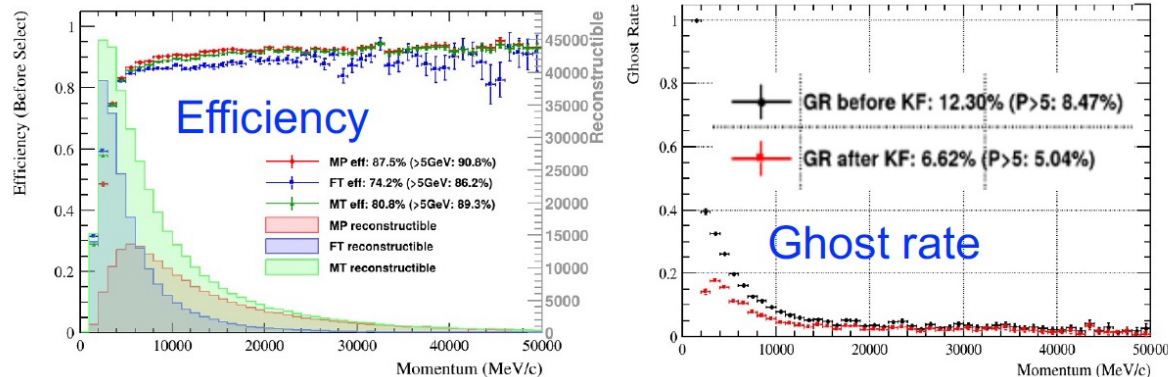


# UP: simulation and performance

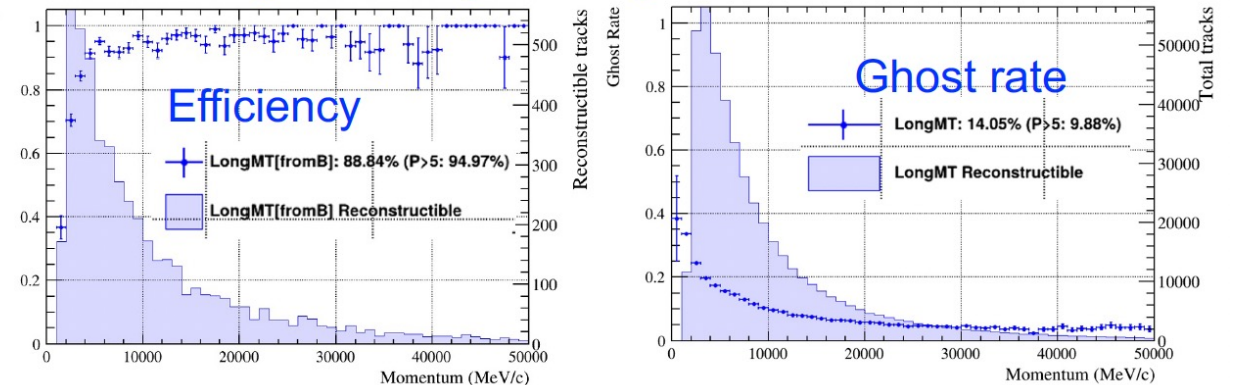
- Standalone UP tracking possible with pixel sensors
- More possibilities in tracking algorithms
  - Forward alg.: VELO  $\rightarrow$  UP / MT
  - Match alg.: VELO + MT  $\rightarrow$  + UP
  - Backward alg. (new!): combine all 3 standalone tracks
- Merging all algorithms give good performance (eff  $\sim$  95%, ghost rate  $O(\%)$ ) as of now, under  $>8$  times more tracks!



Long Tracks by "backward alg"



Long Tracks by all 3 algs. after clone killer



# UP: organization

- Collaborations of 12 groups from China, France, Mongolia and US
  - Chinese groups playing leading role

Project Leader: **Jianchun Wang / IHEP**

Deputy: Tomasz Skwarnicki / Syracuse, Benjamin Audurier / IRFU

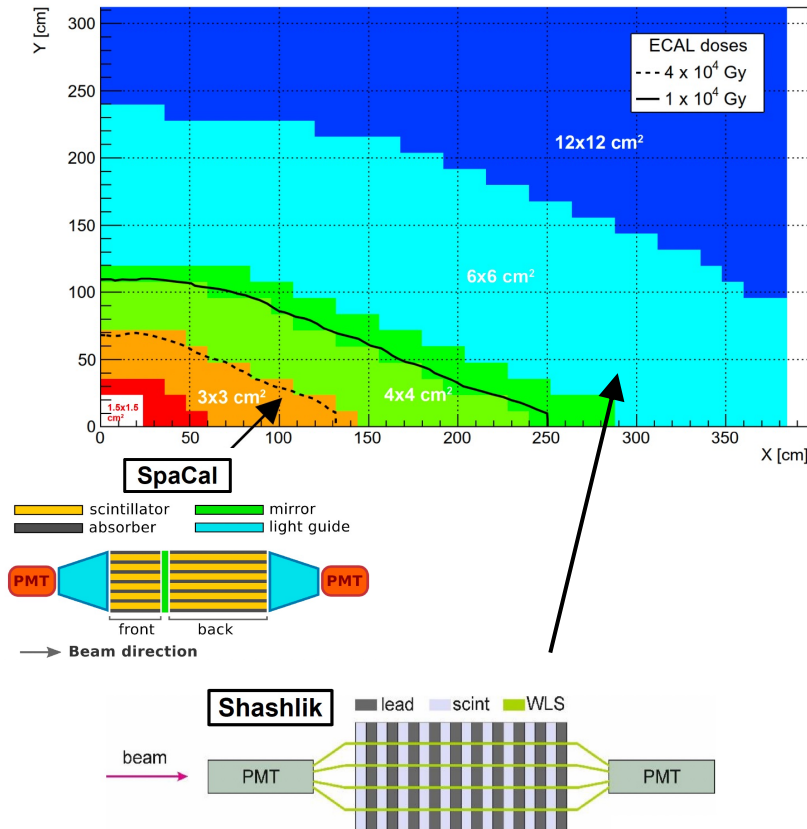
| WPs  | Work Packages and Sub-WPs                    | Leaders   |
|------|--|---|
| WP.0 | TDR preparation                              | Marina Artuso / Syracuse  |
| WP.1 | Simulation, reconstruction and performance   | Xuhao Yuan / IHEP, Steve Blusk / Syracuse                         |
| 1.1  | Detector description and simulation software | Xiaokang Zhou / CCNU  |
| 1.2  | Reconstruction and performance study         | Peilian Li / UCAS   |
| WP.2 | Pixel sensor chip development                | Yiming Li / IHEP, Fabrice Guilloux / IRFU                         |
| 2.1  | Sensor chip design                           | Xiaomin Wei / NPU, Yang Zhou / IHEP                               |
| 2.2  | Sensor chip evaluation                       | Elisabeth Niel / LLR, Hui Zhang / IHEP                            |
| WP.3 | Module and stave                             | Ray Mountain/Syracuse, Jiesheng Yu/HNU, Manuel Guittiere/Subatech |
| 3.1  | Design and prototyping                       | (Xuhao Yuan / IHEP), Theo Bigourdan / Subatech                    |
| 3.2  | Stave mechanical and thermal study           | Yi Yang / HNU, (Arnaud Cadiou / Subatech)                         |
| 3.3  | Module evaluation                            | Charlotte Riccio / IRFU   |
| WP.4 | Overall mechanics, installation and cooling  | Arnaud Cadiou / Subatech  |
| 4.1  | Mechanical support                           | Meriadeg Guillamet / Subatech                                     |
| 4.2  | Detector integration and installation        | Meriadeg Guillamet / Subatech, Bassem Khanji / Syracuse           |
| 4.3  | Cooling system                               | Hangyi Wu / Syracuse  |
| WP.5 | Data acquisition system                      | Kai Chen / CCNU, Zijun Xu / IHEP                                  |
| 5.1  | Overall readout scheme                       | (Jianchun Wang / IHEP)  |
| 5.2  | UP-specific firmware                         | (Kai Chen / CCNU)   |
| 5.3  | Control and monitoring                       | (Zijun Xu / IHEP)   |
| 5.4  | DAQ system for evaluation and production     | (Marina Artuso / Syracuse)  |
| WP.6 | Electronics                                  | Kai Liu / LZU, Christophe Renard / Subatech                       |
| 6.1  | Design of FE electronics                     | Zhiqiang Fu / LZU   |
| 6.2  | HV and LV systems                            | Kechen Li / HTU   |



# ECAL → PicoCAL

- Maintaining ECAL performance
- Inner part using SpaCal and outer keeps Shashlik technology
- Timing of O(10) ps expected

CERN-LHCC-2023-005

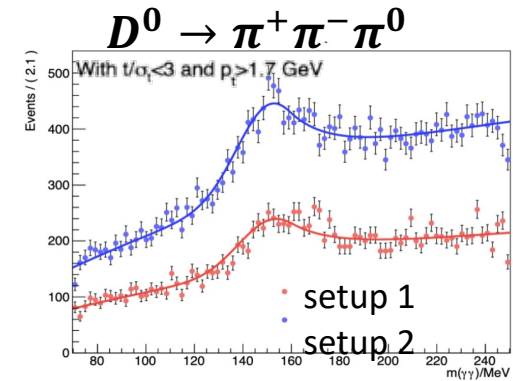
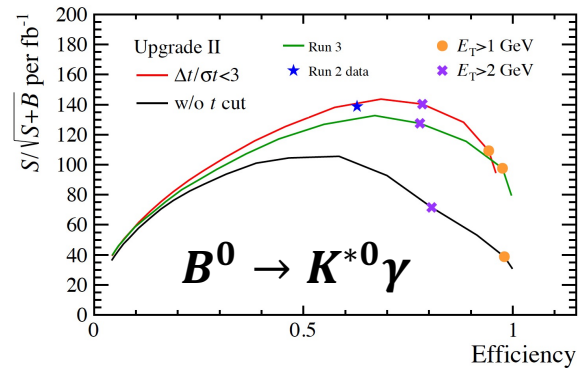
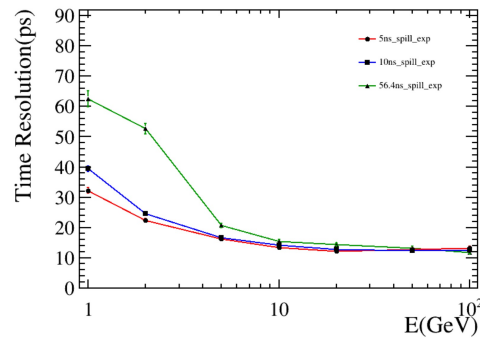
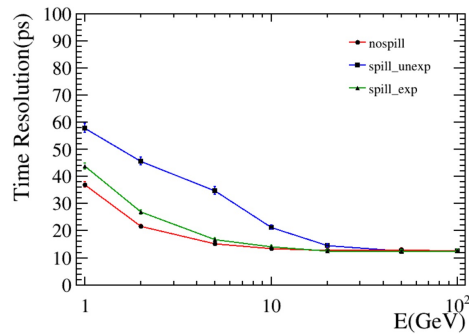


- Chinese groups active in the R&D:
  - Simulation and optimization
  - 3D-printed tungsten absorber
  - GAGG crystal fibre development
  - Light guide
  - SiPM R&D
  - SpaCal module assembly
  - ...

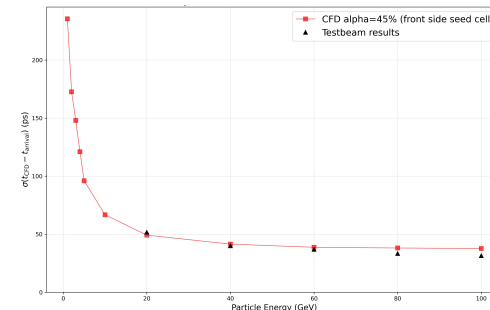
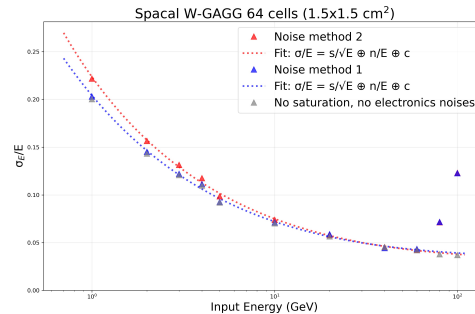
# PicoCAL: progress

- Software and simulation

- Performance studies: decay time impact; timing information
- Software development & optimization of reconstruction algorithm in full swing towards U2 TDR

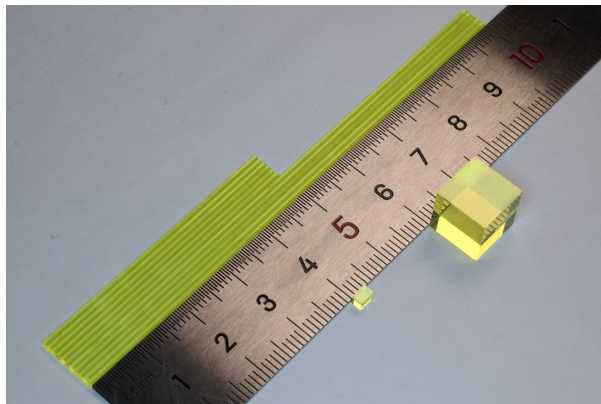


- Templated pulse method developed for digitization, and used in official simulation framework
- Integration of reconstruction algs

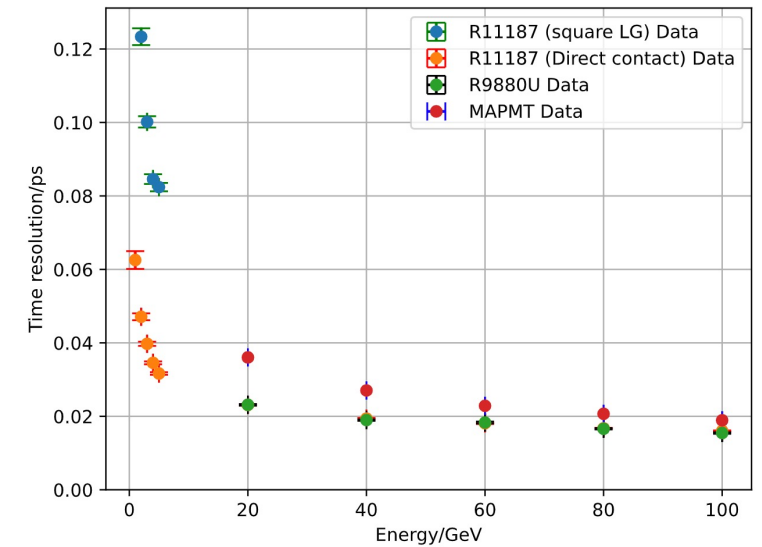
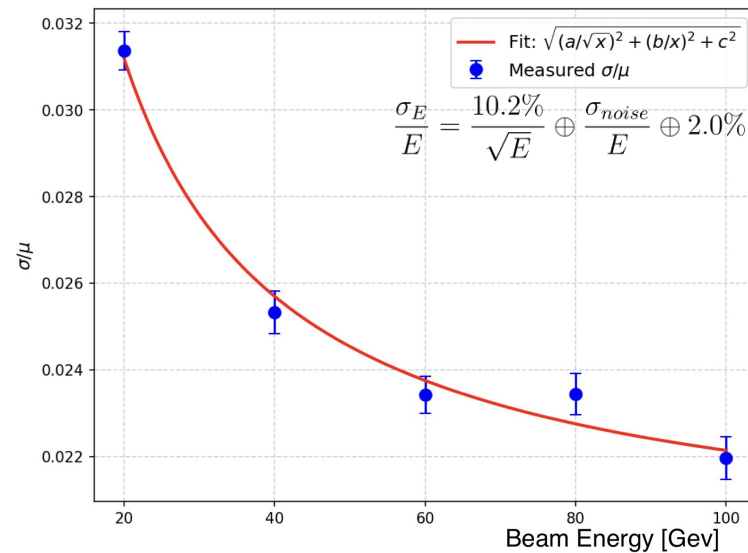


# PicoCAL: progress

- Software and simulation
- Fast GAGG crystal fibre development
  - Collaborating with SiPAT (电科芯片)+CERN starting from end of 2021
  - Gradually reducing effective decay time  $\tau_{\text{eff}}$ : 50 ns (2022)  $\rightarrow$  20 ns (2024)  $\rightarrow$  8 ns (2025)
  - SpaCal-W-GAGG prototype with GAGG with  $\tau_{\text{eff}} \approx 20$  ns, testbeam at SPS+DESY



Increase doping , LY decrease,  
time resolution increase

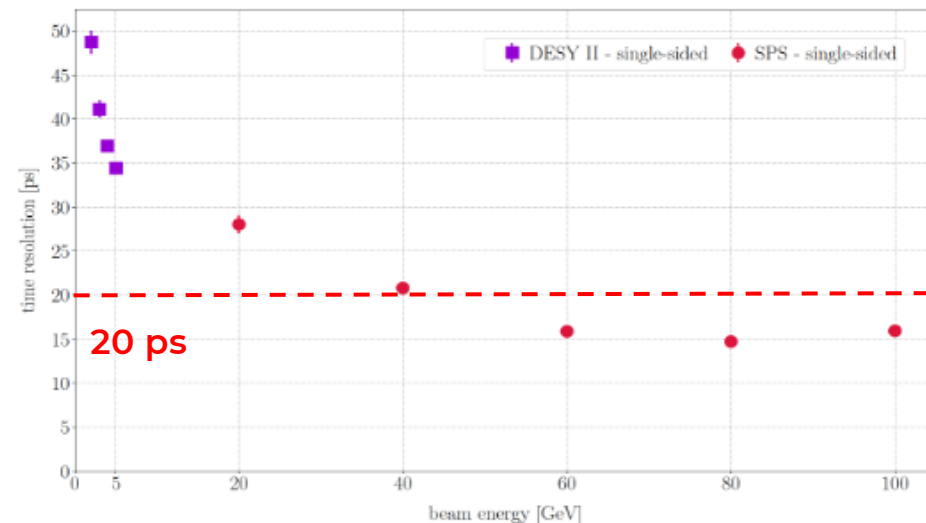
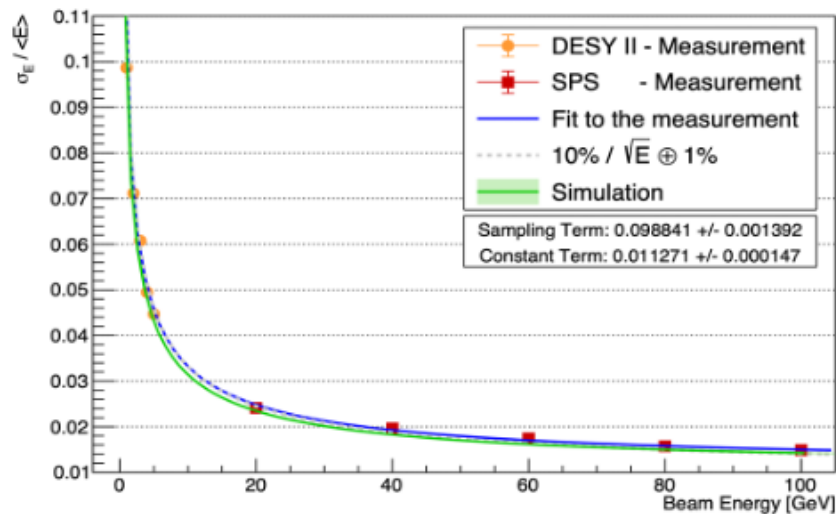
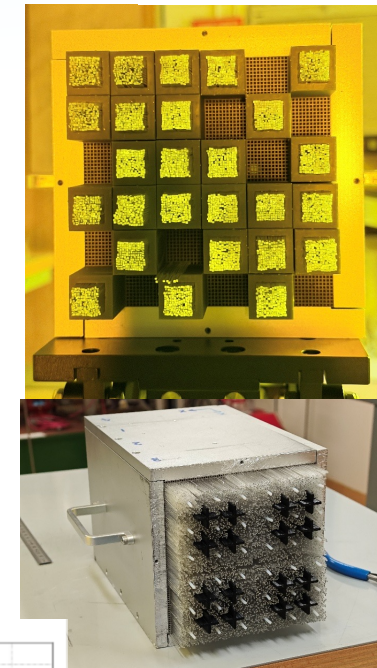
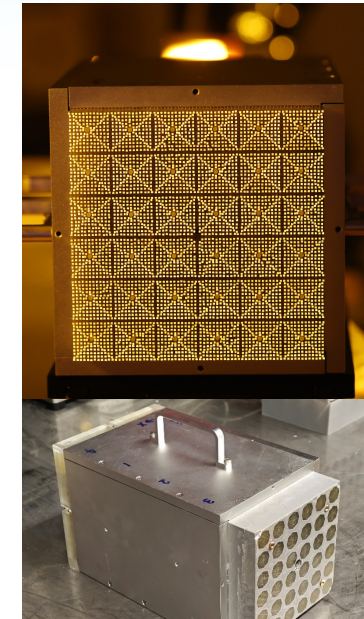


# PicoCAL: progress

Both use W absorbers  
from China group

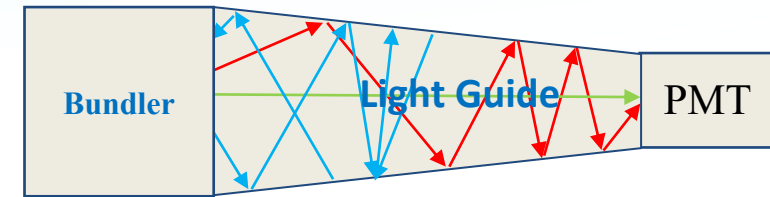


- Software and simulation
- Fast GAGG crystal fibre development
- 3D printed tungsten absorbers
  - Co-developed with LaserAdd (雷佳)
- LS3 SpaCal-W-Polystyrene module assembly
  - Modules assembled in Beijing and tested at CERN beams

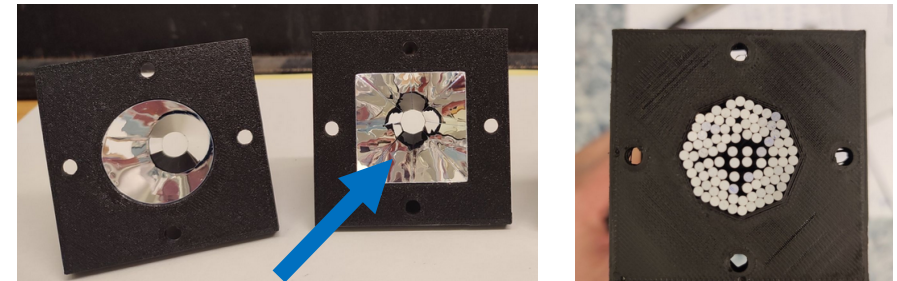


# PicoCAL: progress

- Software and simulation
- Fast GAGG crystal fibre development
- 3D printed tungsten absorbers
- LS3 SpaCal-W-Polystyrene module assembly
- Light-guide system development
  - Radiation-hard hollow light-guide and new fiber bundle process with Chinese provider
- PMT R&D started, collaborating with NNVT(北方夜视)+IHEP



Test light guide and bundler



ESR reflection film

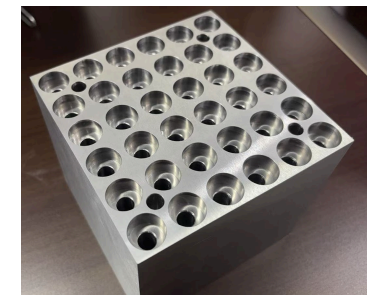
Test different production method



Resin 3D print



Steel 3D print



CNC machining

# ECAL/PicoCal management structure

## ECAL organisation towards LS3 enhancement

ECAL Upgrade Project Leader: Philipp R.  
(since July 2024)

### WP1: Absorbers

CERN & China\*

Hubert G.  
Sergey K. & J. Wang

### WP2: Optics assembly (fibers & lightguides)

Maryland & Milano & China\*

Matteo S. & Z. Yuan

### WP3: Organic & crystal fibers R&D

CERN & China\*

Etiennette A. & Ming Z.

### WP4: PMT & HV & LED system

CERN, ICCUB, CSIC, Maryland, Cincinnati, Bologna, Milano

Phoebe H. & Yuri G. & Conor H.

### WP5: Electronics

IJCLab, LPC, LAPP, ICCUB, CSIC, Syracuse

Patrick R. & Christophe B.

### WP6: Infrastructure (incl. cabling)

CERN, LAPP, Imperial

Rolf L. & Andrei G.

### WP7: Detector Software

CERN, China\*, Le Salle, Milano-Bicocca, Padova, MIT, Syracuse

Marco P. & Liupan A.

### WP8: Testbeam coordination & analysis

CERN & All

Loris M. & Daniele M.

\* China: Peking, Tsinghua, Wuhan, SCNU



# Upgrade II physics potential



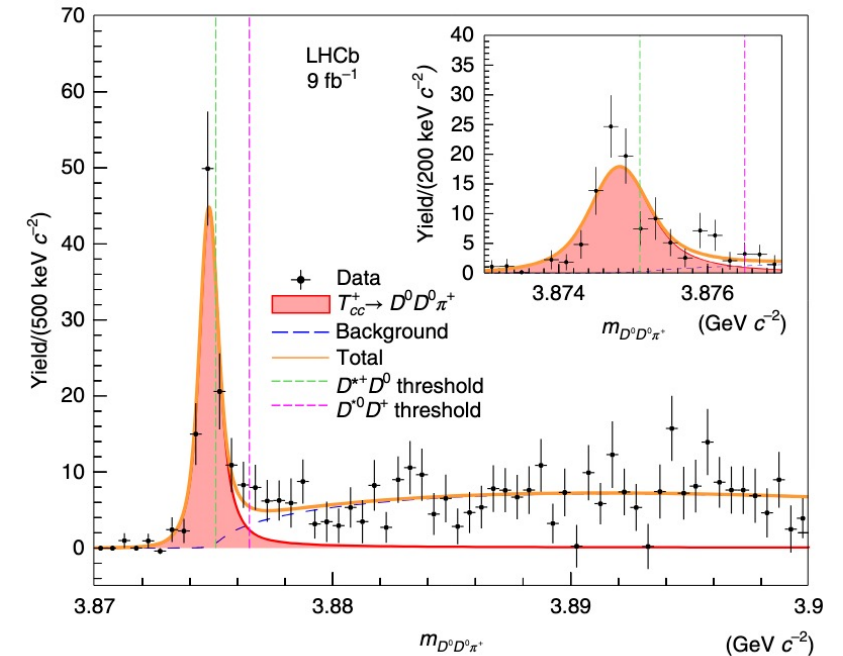
# An example: search for $T_{bc}$

- $T_{cc}$  ( $cc\bar{u}\bar{d}$ ) discovery in  $DD\pi^+$  final state
- Similar tetraquark states  $T_{bc}(bc\bar{u}\bar{d})$ ?
  - Mass prediction around BD threshold (-50, 120)MeV

W. Chen, T.G.Steele, S.-L. Zhu, PRD 89 (2014) 054037  
 M. Karliner, J.L.Rosner, PRL 119 (2017) 202001  
 T.F.Carames, J.Vijande, A. Valcarce, PRD 99 (2019) 014006  
 A.Radhakrishnan, M.Padmanath, N.Mathur, PRD 110 (2024) 034506  
 S.Meinel, M.Pflaumer, M.Wagner, PRD 106 (2022) 034507  
 W.L.Wu, Y.Ma, Y.-K. Chen, L.Meng, S.-L. Zhu, PRD 110 (2024) 094041

Above BD threshold {  
 D.Ebert, R.N.Faustov, V.O.Galkin, W.Lucha, PRD 76 (2007) 114015  
 E.J.Eichten, C. Quigg, PRL 119 (2017) 202002  
 J.-B. Cheng, S.-Y. Li, Y.-R. Liu, Z.-G. Si, T. Yao, CPC 45 (2021) 043102  
 Y. Song, D. Jia, Comm. Theo. Phys. 75 (2023) 055201

- If  $m(T_{bc}) > m(B) + m(D)$  can decay strongly



Nature Phys. 18 (2022) 7

# Background to strongly decaying $T_{bc}$

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- Main background: associate production of B and D mesons
- Use MadGraph\_aMC@NLO to simulate SPS & DPS contribution

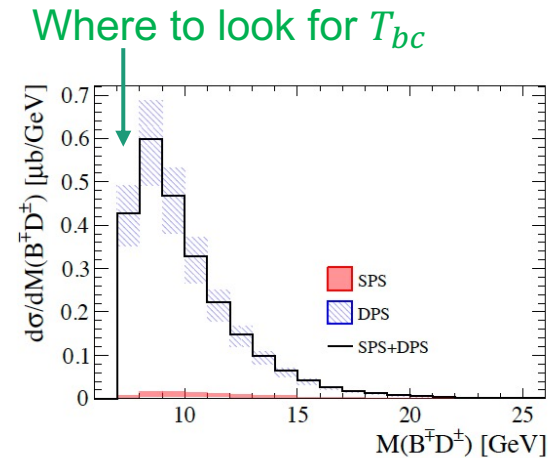
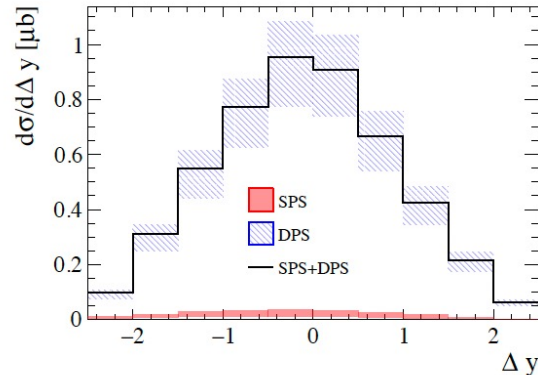
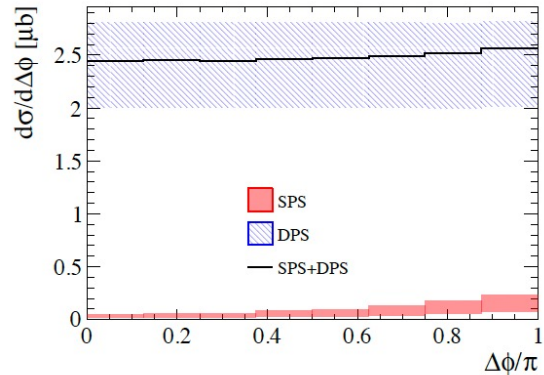
$$T_{bc} \rightarrow B^- D^+,$$

$$B^- \rightarrow J/\psi(\rightarrow \mu^+ \mu^-) K^-,$$

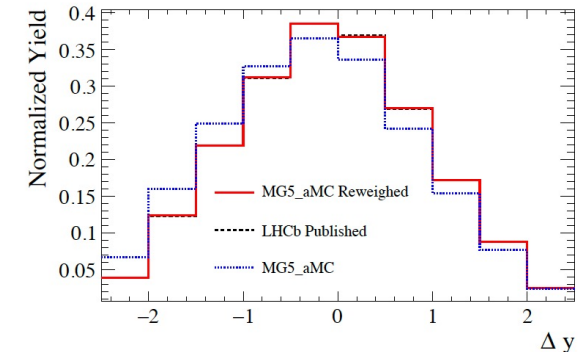
$$D^+ \rightarrow K^- \pi^+ \pi^+,$$

Using published LHCb B and D production paper to weight DPS contribution

$$\sigma(BD) = \frac{\sigma(B) \times \sigma(D)}{\sigma_{\text{eff}}}$$



$\sigma_{\text{eff}} = 15 \text{ mb}$   
also scanned for 5, 30 mb



# $T_{bc}$ assumption

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accepted by CPC

## ■ Cross-section prediction

- Optimistic: 103 nb      A. Ali, Q. Qin, W. Wang, PLB 785 (2018) 605
- Pessimistic: 0.3 nb      Y.-Q. Chen, S.-Z. Wu, PLB 705 (2011) 93
- Intermediate: 18 nb

$$\sigma(T_{bc}) \approx \sigma(T_{cc}^+) \times \frac{\sigma(\Xi_{bc})}{\sigma(\Xi_{cc})} \approx 45 \times 0.4 \approx 18 \text{ nb},$$

Derived from  $T_{cc}$ ;  $T_{cc}$  xsec prediction from  
A. Ali, I. Ahmed, M.J.Aslam, PLB 855 (2024) 138779  
 $X_{ibc}/X_{icc}$  ratio from J.W.Zhang, X.G.Wu, T. Zhong  
PRD 83 (2011) 034026

## ■ Mass / Width

| $m(T_{bc})$ [MeV] | $\Gamma(T_{bc})$ [MeV] | $\sigma(T_{bc})$ [nb] |
|-------------------|------------------------|-----------------------|
| 7167              | 0.5                    | 0.3, 18, 103          |
|                   | 5                      | 0.3, 18, 103          |
| 7229              | 10                     | 0.3, 18, 103          |
|                   | 40                     | 0.3, 18, 103          |

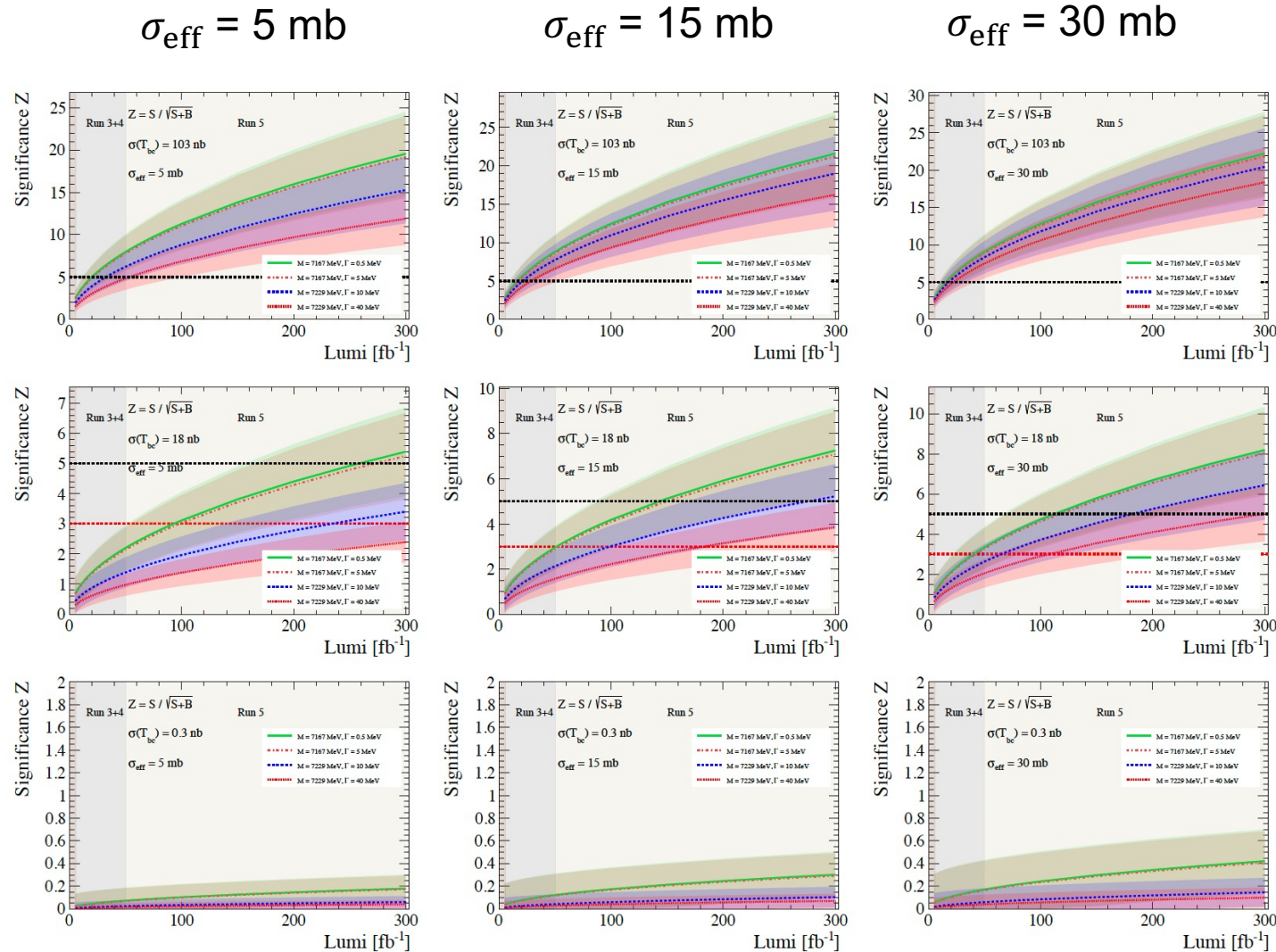
# Sensitivity to strongly decaying $T_{bc}$

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$\sigma(T_{bc}) = 103 \text{ nb}$

$\sigma(T_{bc}) = 18 \text{ nb}$

$\sigma(T_{bc}) = 0.3 \text{ nb}$



Run 3+4

Run 5

Data after Upgrade II  
needed for  $5\sigma$   
discovery in most  
parameter space!

# Summary

- LHCb is taking data at full speed after Upgrade I with improved performance, especially trigger efficiency for hadronic final states
- Development for Upgrade II is ongoing with innovative technologies
- LHCb-China contributed in U1, and leading in many aspects in UII activities exploiting domestic technology
- Upgrade II will be a rich mine for heavy flavour physics, and QCD

Thank you and stay tuned